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# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	196
Number of Logic Elements/Cells	1960
Total RAM Bits	-
Number of I/O	218
Number of Gates	24000
Voltage - Supply	3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BBGA
Supplier Device Package	256-BGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf6024abc256-3

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# ...and More Features

- Powerful I/O pins
  - Individual tri-state output enable control for each pin
  - Programmable output slew-rate control to reduce switching noise
  - Fast path from register to I/O pin for fast clock-to-output time
- Flexible interconnect
  - FastTrack<sup>®</sup> Interconnect continuous routing structure for fast, predictable interconnect delays
  - Dedicated carry chain that implements arithmetic functions such as fast adders, counters, and comparators (automatically used by software tools and megafunctions)
  - Dedicated cascade chain that implements high-speed, high-fanin logic functions (automatically used by software tools and megafunctions)
  - Tri-state emulation that implements internal tri-state networks
  - Four low-skew global paths for clock, clear, preset, or logic signals
- Software design support and automatic place-and-route provided by Altera's development system for Windows-based PCs, Sun SPARCstations, and HP 9000 Series 700/800
- Flexible package options
  - Available in a variety of packages with 100 to 256 pins, including the innovative FineLine BGA<sup>TM</sup> packages (see Table 2)
  - SameFrame<sup>TM</sup> pin-compatibility (with other FLEX® 6000 devices) across device densities and pin counts
  - Thin quad flat pack (TQFP), plastic quad flat pack (PQFP), and ball-grid array (BGA) packages (see Table 2)
  - Footprint- and pin-compatibility with other FLEX 6000 devices in the same package
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, the library of parameterized modules (LPM), Verilog HDL, VHDL, DesignWare components, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, VeriBest, and Viewlogic

Table 2. F	Table 2. FLEX 6000 Package Options & I/O Pin Count								
Device	100-Pin TQFP	100-Pin FineLine BGA	144-Pin TQFP	208-Pin PQFP	240-Pin PQFP	256-Pin BGA	256-pin FineLine BGA		
EPF6010A	71		102						
EPF6016			117	171	199	204			
EPF6016A	81	81	117	171			171		
EPF6024A			117	171	199	218	219		

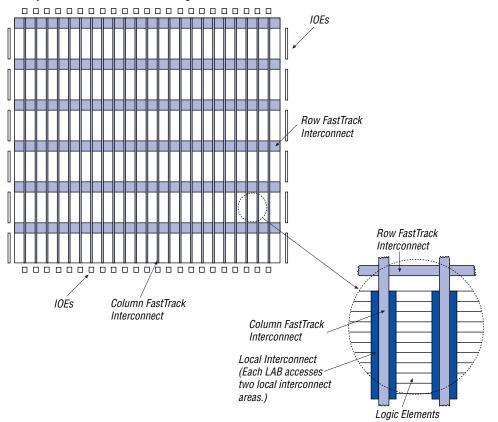


Figure 1. OptiFLEX Architecture Block Diagram

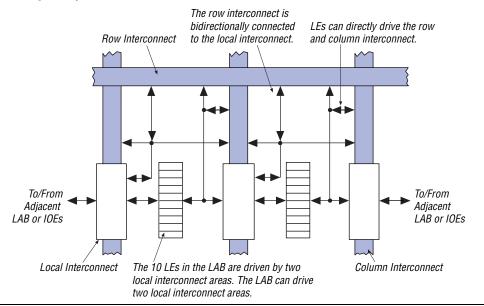
FLEX 6000 devices provide four dedicated, global inputs that drive the control inputs of the flipflops to ensure efficient distribution of high-speed, low-skew control signals. These inputs use dedicated routing channels that provide shorter delays and lower skews than the FastTrack Interconnect. These inputs can also be driven by internal logic, providing an ideal solution for a clock divider or an internally generated asynchronous clear signal that clears many registers in the device. The dedicated global routing structure is built into the device, eliminating the need to create a clock tree.

# **Logic Array Block**

An LAB consists of ten LEs, their associated carry and cascade chains, the LAB control signals, and the LAB local interconnect. The LAB provides the coarse-grained structure of the FLEX 6000 architecture, and facilitates efficient routing with optimum device utilization and high performance.

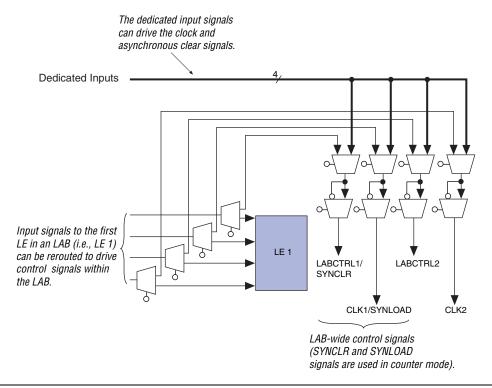
The interleaved LAB structure—an innovative feature of the FLEX 6000 architecture—allows each LAB to drive two local interconnects. This feature minimizes the use of the FastTrack Interconnect, providing higher performance. An LAB can drive 20 LEs in adjacent LABs via the local interconnect, which maximizes fitting flexibility while minimizing die size. See Figure 2.

Figure 2. Logic Array Block



In most designs, the registers only use global clock and clear signals. However, in some cases, other clock or asynchronous clear signals are needed. In addition, counters may also have synchronous clear or load signals. In a design that uses non-global clock and clear signals, inputs from the first LE in an LAB are re-routed to drive the control signals for that LAB. See Figure 3.

Figure 3. LAB Control Signals



### **Logic Element**

An LE, the smallest unit of logic in the FLEX 6000 architecture, has a compact size that provides efficient logic usage. Each LE contains a four-input LUT, which is a function generator that can quickly implement any function of four variables. An LE contains a programmable flipflop, carry and cascade chains. Additionally, each LE drives both the local and the FastTrack Interconnect. See Figure 4.

### Carry Chain

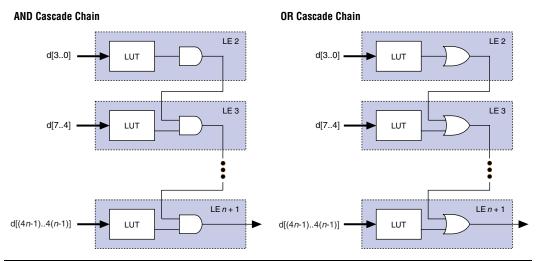
The carry chain provides a very fast (0.1 ns) carry-forward function between LEs. The carry-in signal from a lower-order bit drives forward into the higher-order bit via the carry chain, and feeds into both the LUT and the next portion of the carry chain. This feature allows the FLEX 6000 architecture to implement high-speed counters, adders, and comparators of arbitrary width. Carry chain logic can be created automatically by the Altera software during design processing, or manually by the designer during design entry. Parameterized functions such as LPM and DesignWare functions automatically take advantage of carry chains for the appropriate functions.

Because the first LE of each LAB can generate control signals for that LAB, the first LE in each LAB is not included in carry chains. In addition, the inputs of the first LE in each LAB may be used to generate synchronous clear and load enable signals for counters implemented with carry chains.

Carry chains longer than nine LEs are implemented automatically by linking LABs together. For enhanced fitting, a long carry chain skips alternate LABs in a row. A carry chain longer than one LAB skips either from an even-numbered LAB to another even-numbered LAB, or from an odd-numbered LAB to another odd-numbered LAB. For example, the last LE of the first LAB in a row carries to the second LE of the third LAB in the row. In addition, the carry chain does not cross the middle of the row. For instance, in the EPF6016 device, the carry chain stops at the 11th LAB in a row and a new carry chain begins at the 12th LAB.

Figure 5 shows how an n-bit full adder can be implemented in n+1 LEs with the carry chain. One portion of the LUT generates the sum of two bits using the input signals and the carry-in signal; the sum is routed to the output of the LE. Although the register can be bypassed for simple adders, it can be used for an accumulator function. Another portion of the LUT and the carry chain logic generates the carry-out signal, which is routed directly to the carry-in signal of the next-higher-order bit. The final carry-out signal is routed to an LE, where it is driven onto the FastTrack Interconnect.

Figure 6. Cascade Chain Operation



### LE Operating Modes

The FLEX 6000 LE can operate in one of the following three modes:

- Normal mode
- Arithmetic mode
- Counter mode

Each of these modes uses LE resources differently. In each mode, seven available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. LAB-wide signals provide clock, asynchronous clear, synchronous clear, and synchronous load control for the register. The Altera software, in conjunction with parameterized functions such as LPM and DesignWare functions, automatically chooses the appropriate mode for common functions such as counters, adders, and multipliers. If required, the designer can also create special-purpose functions to use an LE operating mode for optimal performance.

Figure 7 shows the LE operating modes.

#### **Normal Mode**

The normal mode is suitable for general logic applications, combinatorial functions, or wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in are inputs to a 4-input LUT. The Altera software automatically selects the carry-in or the DATA3 signal as one of the inputs to the LUT. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal.

#### Arithmetic Mode

The arithmetic mode is ideal for implementing adders, accumulators, and comparators. An LE in arithmetic mode uses two 3-input LUTs. One LUT computes a 3-input function; the other generates a carry output. As shown in Figure 7, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, when implementing an adder, this output is the sum of three signals: DATA1, DATA2, and carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports simultaneous use of the cascade chain.

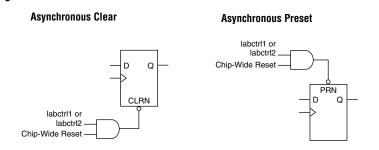
The Altera software implements logic functions to use the arithmetic mode automatically where appropriate; the designer does not have to decide how the carry chain will be used.

#### **Counter Mode**

The counter mode offers counter enable, synchronous up/down control, synchronous clear, and synchronous load options. The counter enable and synchronous up/down control signals are generated from the data inputs of the LAB local interconnect. The synchronous clear and synchronous load options are LAB-wide signals that affect all registers in the LAB. Consequently, if any of the LEs in a LAB use counter mode, other LEs in that LAB must be used as part of the same counter or be used for a combinatorial function. In addition, the Altera software automatically places registers that are not in the counter into other LABs.

The counter mode uses two 3-input LUTs: one generates the counter data and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading, and another AND gate provides synchronous clearing. If the cascade function is used by an LE in counter mode, the synchronous clear or load will override any signal carried on the cascade chain. The synchronous clear overrides the synchronous load.

Figure 8. LE Clear & Preset Modes



#### Asynchronous Clear

The flipflop can be cleared by either LABCTRL1 or LABCTRL2.

#### **Asynchronous Preset**

An asynchronous preset is implemented with an asynchronous clear. The Altera software provides preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, this technique can be used when a register drives logic or drives a pin.

In addition to the two clear and preset modes, FLEX 6000 devices provide a chip-wide reset pin (DEV\_CLRn) that can reset all registers in the device. The option to use this pin is set in the Altera software before compilation. The chip-wide reset overrides all other control signals. Any register with an asynchronous preset will be preset when the chip-wide reset is asserted because of the inversion technique used to implement the asynchronous preset.

The Altera software can use a programmable NOT-gate push-back technique to emulate simultaneous preset and clear or asynchronous load. However, this technique uses an additional three LEs per register.

#### FastTrack Interconnect

In the FLEX 6000 OptiFLEX architecture, connections between LEs and device I/O pins are provided by the FastTrack Interconnect, a series of continuous horizontal and vertical routing channels that traverse the device. This global routing structure provides predictable performance, even for complex designs. In contrast, the segmented routing in FPGAs requires switch matrices to connect a variable number of routing paths, increasing the delays between logic resources and reducing performance.

Each LE FastTrack Interconnect output can drive six row channels. Each local channel driven by an LE can Each LE output signal driving drive two column the FastTrack Interconnect can channels. drive two column channels. At each intersection, four row channels can Row drive column channels. Interconnect Each local channel driven by an LE can drive four row channels. Row interconnect drives the local interconnect. From Adjacent Local Interconnect Local Interconnect Column Interconnect Any column channel can drive six row channels.

An LE can be driven by any signal from two local interconnect areas.

Figure 10. LAB Connections to Row & Column Interconnects

For improved routability, the row interconnect consists of full-length and half-length channels. The full-length channels connect to all LABs in a row; the half-length channels connect to the LABs in half of the row. In addition to providing a predictable, row-wide interconnect, this architecture provides increased routing resources. Two neighboring LABs can be connected using a half-length channel, which saves the other half of the channel for the other half of the row. One-third of the row channels are half-length channels.

### I/O Elements

An IOE contains a bidirectional I/O buffer and a tri-state buffer. IOEs can be used as input, output, or bidirectional pins. An IOE receives its data signals from the adjacent local interconnect, which can be driven by a row or column interconnect (allowing any LE in the device to drive the IOE) or by an adjacent LE (allowing fast clock-to-output delays). A FastFLEX<sup>TM</sup> I/O pin is a row or column output pin that receives its data signals from the adjacent local interconnect driven by an adjacent LE. The IOE receives its output enable signal through the same path, allowing individual output enables for every pin and permitting emulation of open-drain buffers. The Altera Compiler uses programmable inversion to invert the data or output enable signals automatically where appropriate. Open-drain emulation is provided by driving the data input low and toggling the OE of each IOE. This emulation is possible because there is one OE per pin.

A chip-wide output enable feature allows the designer to disable all pins of the device by asserting one pin (DEV\_OE). This feature is useful during board debugging or testing.

Figure 12 shows the IOE block diagram.

To Row or Column Interconnect

Chip-Wide Output Enable

From LAB Local Interconnect

Slew-Rate
Control

Figure 12. IOE Block Diagram

Symbol	Parameter	Min	Max	Unit
t <sub>JCP</sub>	TCK clock period	100		ns
t <sub>JCH</sub>	TCK clock high time	50		ns
t <sub>JCL</sub>	TCK clock low time	50		ns
t <sub>JPSU</sub>	JTAG port setup time	20		ns
t <sub>JPH</sub>	JTAG port hold time	45		ns
t <sub>JPCO</sub>	JTAG port clock-to-output		25	ns
t <sub>JPZX</sub>	JTAG port high impedance to valid output		25	ns
t <sub>JPXZ</sub>	JTAG port valid output to high impedance		25	ns
t <sub>JSSU</sub>	Capture register setup time	20		ns
t <sub>JSH</sub>	Capture register hold time	45		ns
t <sub>JSCO</sub>	Update register clock-to-output		35	ns
t <sub>JSZX</sub>	Update register high impedance to valid output		35	ns
t <sub>JSXZ</sub>	Update register valid output to high impedance		35	ns

# **Generic Testing**

Each FLEX 6000 device is functionally tested. Complete testing of each configurable SRAM bit and all logic functionality ensures 100% configuration yield. AC test measurements for FLEX 6000 devices are made under conditions equivalent to those shown in Figure 17. Multiple test patterns can be used to configure devices during all stages of the production flow.

#### Figure 17. AC Test Conditions

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers without parentheses are for 5.0-V devices or outputs. Numbers in parentheses are for 3.3-V devices or outputs. Numbers in brackets are for 2.5-V devices or outputs.

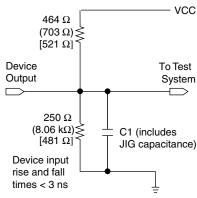


Table 15. FLEX 6000 3.3-V Device Absolute Maximum Ratings Note (1)								
Symbol	Parameter	Conditions	Min	Max	Unit			
V <sub>CC</sub>	Supply voltage	With respect to ground (2)	-0.5	4.6	V			
V <sub>I</sub>	DC input voltage		-2.0	5.75	٧			
I <sub>OUT</sub>	DC output current, per pin		-25	25	mA			
T <sub>STG</sub>	Storage temperature	No bias	-65	150	° C			
T <sub>AMB</sub>	Ambient temperature	Under bias	-65	135	° C			
T <sub>J</sub>	Junction temperature	PQFP, PLCC, and BGA packages		135	° C			

Table 1	Table 16. FLEX 6000 3.3-V Device Recommended Operating Conditions							
Symbol	Parameter	Conditions	Min	Max	Unit			
V <sub>CCINT</sub>	Supply voltage for internal logic and input buffers	(3), (4)	3.00 (3.00)	3.60 (3.60)	V			
V <sub>CCIO</sub>	Supply voltage for output buffers, 3.3-V operation	(3), (4)	3.00 (3.00)	3.60 (3.60)	V			
	Supply voltage for output buffers, 2.5-V operation	(3), (4)	2.30 (2.30)	2.70 (2.70)	V			
VI	Input voltage		-0.5	5.75	٧			
V <sub>O</sub>	Output voltage		0	V <sub>CCIO</sub>	V			
$T_J$	Operating temperature	For commercial use	0	85	° C			
		For industrial use	-40	100	°C			
t <sub>R</sub>	Input rise time			40	ns			
t <sub>F</sub>	Input fall time			40	ns			

# **Timing Model**

The continuous, high-performance FastTrack Interconnect routing resources ensure predictable performance and accurate simulation and timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and therefore have unpredictable performance.

Device performance can be estimated by following the signal path from a source, through the interconnect, to the destination. For example, the registered performance between two LEs on the same row can be calculated by adding the following parameters:

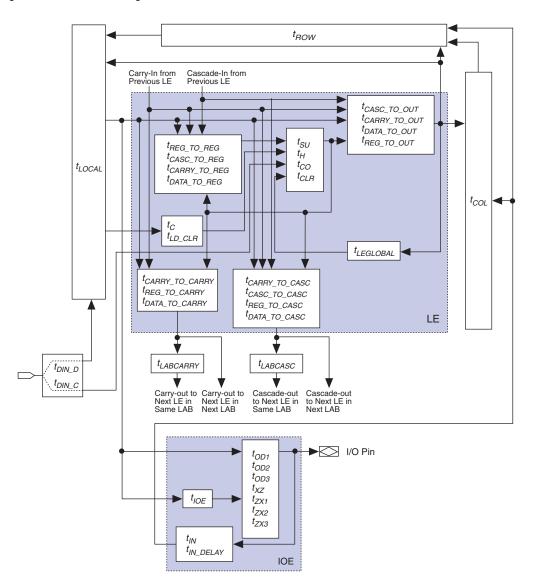
- LE register clock-to-output delay ( $t_{CO} + t_{REG\_TO\_OUT}$ )
- Routing delay  $(t_{ROW} + t_{LOCAL})$
- LE LUT delay ( $t_{DATA\_TO\_REG}$ )
- LE register setup time  $(t_{SU})$

The routing delay depends on the placement of the source and destination LEs. A more complex registered path may involve multiple combinatorial LEs between the source and destination LEs.

Timing simulation and delay prediction are available with the Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time analysis, and device-wide performance analysis.

Figure 19 shows the overall timing model, which maps the possible routing paths to and from the various elements of the FLEX 6000 device.

Figure 19. FLEX 6000 Timing Model



Tables 19 through 21 describe the FLEX 6000 internal timing microparameters, which are expressed as worst-case values. Using hand calculations, these parameters can be used to estimate design performance. However, before committing designs to silicon, actual worst-case performance should be modeled using timing simulation and timing analysis. Tables 22 and 23 describe FLEX 6000 external timing parameters.

Symbol	Parameter	Conditions
t <sub>REG_TO_REG</sub>	LUT delay for LE register feedback in carry chain	
t <sub>CASC_TO_REG</sub>	Cascade-in to register delay	
t <sub>CARRY_TO_REG</sub>	Carry-in to register delay	
t <sub>DATA_TO_REG</sub>	LE input to register delay	
t <sub>CASC_TO_OUT</sub>	Cascade-in to LE output delay	
t <sub>CARRY_TO_OUT</sub>	Carry-in to LE output delay	
t <sub>DATA_TO_OUT</sub>	LE input to LE output delay	
t <sub>REG_TO_OUT</sub>	Register output to LE output delay	
t <sub>SU</sub>	LE register setup time before clock; LE register recovery time after asynchronous clear	
t <sub>H</sub>	LE register hold time after clock	
$t_{CO}$	LE register clock-to-output delay	
t <sub>CLR</sub>	LE register clear delay	
$t_C$	LE register control signal delay	
t <sub>LD_CLR</sub>	Synchronous load or clear delay in counter mode	
t <sub>CARRY_TO_CARRY</sub>	Carry-in to carry-out delay	
t <sub>REG_TO_CARRY</sub>	Register output to carry-out delay	
t <sub>DATA_TO_CARRY</sub>	LE input to carry-out delay	
t <sub>CARRY_TO_CASC</sub>	Carry-in to cascade-out delay	
t <sub>CASC_TO_CASC</sub>	Cascade-in to cascade-out delay	
t <sub>REG_TO_CASC</sub>	Register-out to cascade-out delay	
t <sub>DATA_TO_CASC</sub>	LE input to cascade-out delay	
t <sub>CH</sub>	LE register clock high time	
$t_{CL}$	LE register clock low time	
	+	-

Tables 29 through 33 show the timing information for EPF6016 devices.

Parameter	Speed Grade					
	-2		-3			
	Min	Max	Min	Max		
t <sub>REG_TO_REG</sub>		2.2		2.8	ns	
t <sub>CASC_TO_REG</sub>		0.9		1.2	ns	
t <sub>CARRY_TO_REG</sub>		1.6		2.1	ns	
t <sub>DATA_TO_REG</sub>		2.4		3.0	ns	
t <sub>CASC_TO_OUT</sub>		1.3		1.7	ns	
t <sub>CARRY_TO_OUT</sub>		2.4		3.0	ns	
t <sub>DATA_TO_OUT</sub>		2.7		3.4	ns	
t <sub>REG_TO_OUT</sub>		0.3		0.5	ns	
t <sub>SU</sub>	1.1		1.6		ns	
t <sub>H</sub>	1.8		2.3		ns	
$t_{CO}$		0.3		0.4	ns	
t <sub>CLR</sub>		0.5		0.6	ns	
$t_C$		1.2		1.5	ns	
t <sub>LD_CLR</sub>		1.2		1.5	ns	
t <sub>CARRY_TO_CARRY</sub>		0.2		0.4	ns	
t <sub>REG_TO_CARRY</sub>		0.8		1.1	ns	
t <sub>DATA_TO_CARRY</sub>		1.7		2.2	ns	
t <sub>CARRY_TO_CASC</sub>		1.7		2.2	ns	
t <sub>CASC_TO_CASC</sub>		0.9		1.2	ns	
t <sub>REG_TO_CASC</sub>		1.6		2.0	ns	
t <sub>DATA_TO_CASC</sub>		1.7		2.1	ns	
t <sub>CH</sub>	4.0		4.0		ns	
t <sub>CL</sub>	4.0		4.0		ns	

Parameter	Speed Grade				
	-	2	-3		
	Min	Max	Min	Max	
t <sub>OD1</sub>		2.3		2.8	ns
t <sub>OD2</sub>		4.6		5.1	ns

Parameter		Speed	Grade		Unit
	-	2	-	3	
	Min	Max	Min	Max	
OD3		4.7		5.2	ns
XZ		2.3		2.8	ns
ZX1		2.3		2.8	ns
ZX2		4.6		5.1	ns
ZX3		4.7		5.2	ns
IOE		0.5		0.6	ns
<sup>t</sup> in		3.3		4.0	ns
t <sub>IN DELAY</sub>		4.6		5.6	ns

Parameter		Speed	Grade		Unit
	-2		-3		
	Min	Max	Min	Max	
t <sub>LOCAL</sub>		0.8		1.0	ns
t <sub>ROW</sub>		2.9		3.3	ns
t <sub>COL</sub>		2.3		2.5	ns
t <sub>DIN_D</sub>		4.9		6.0	ns
t <sub>DIN_C</sub>		4.8		6.0	ns
t <sub>LEGLOBAL</sub>		3.1		3.9	ns
t <sub>LABCARRY</sub>		0.4		0.5	ns
t <sub>LABCASC</sub>		0.8		1.0	ns

Table 32. External Reference Timing Parameters for EPF6016 Devices						
Parameter Speed Grade						
		-2				
	Min	Max	Min	Max		
t <sub>1</sub>		53.0		65.0	ns	
t <sub>DRR</sub>		16.0		20.0	ns	

Table 33. External Timing Parameters for EPF6016 Devices							
Parameter		Speed Grade					
		-2		-3			
	Min	Max	Min	Max			
t <sub>INSU</sub>	3.2		4.1		ns		
t <sub>INH</sub>	0.0		0.0		ns		
t <sub>оитсо</sub>	2.0	7.9	2.0	9.9	ns		

Tables 34 through 38 show the timing information for EPF6024A devices.

Parameter	Speed Grade							
	-1		-2		-3			
	Min	Max	Min	Max	Min	Max	1	
t <sub>REG_TO_REG</sub>		1.2		1.3		1.6	ns	
t <sub>CASC_TO_REG</sub>		0.7		0.8		1.0	ns	
t <sub>CARRY_TO_REG</sub>		1.6		1.8		2.2	ns	
t <sub>DATA_TO_REG</sub>		1.3		1.4		1.7	ns	
t <sub>CASC_TO_OUT</sub>		1.2		1.3		1.6	ns	
t <sub>CARRY_TO_OUT</sub>		2.0		2.2		2.6	ns	
t <sub>DATA_TO_OUT</sub>		1.8		2.1		2.6	ns	
t <sub>REG_TO_OUT</sub>		0.3		0.3		0.4	ns	
t <sub>SU</sub>	0.9		1.0		1.2		ns	
t <sub>H</sub>	1.3		1.4		1.7		ns	
$t_{CO}$		0.2		0.3		0.3	ns	
t <sub>CLR</sub>		0.3		0.3		0.4	ns	
$t_C$		1.9		2.1		2.5	ns	
t <sub>LD_CLR</sub>		1.9		2.1		2.5	ns	
t <sub>CARRY_TO_CARRY</sub>		0.2		0.2		0.3	ns	
t <sub>REG_TO_CARRY</sub>		1.4		1.6		1.9	ns	
t <sub>DATA_TO_CARRY</sub>		1.3	_	1.4	_	1.7	ns	
t <sub>CARRY_TO_CASC</sub>		1.1		1.2		1.4	ns	
t <sub>CASC_TO_CASC</sub>		0.7		0.8		1.0	ns	
t <sub>REG_TO_CASC</sub>		1.4		1.6		1.9	ns	
t <sub>DATA_TO_CASC</sub>		1.0		1.1		1.3	ns	
t <sub>CH</sub>	2.5		3.0		3.5		ns	
t <sub>CL</sub>	2.5		3.0		3.5		ns	

Parameter	Speed Grade							
	-1		-2		-3			
	Min	Max	Min	Max	Min	Max		
t <sub>OD1</sub>		1.9		2.1		2.5	ns	
t <sub>OD2</sub>		4.0		4.4		5.3	ns	
t <sub>OD3</sub>		7.0		7.8		9.3	ns	
$t_{XZ}$		4.3		4.8		5.8	ns	
$t_{XZ1}$		4.3		4.8		5.8	ns	
$t_{XZ2}$		6.4		7.1		8.6	ns	
t <sub>XZ3</sub>		9.4		10.5		12.6	ns	
<sup>t</sup> IOE		0.5		0.6		0.7	ns	
İN		3.3		3.7		4.4	ns	
t <sub>IN DELAY</sub>		5.3		5.9		7.0	ns	

Parameter	Speed Grade							
	-1		-2		-3			
	Min	Max	Min	Max	Min	Max		
t <sub>LOCAL</sub>		0.8		0.8		1.1	ns	
t <sub>ROW</sub>		3.0		3.1		3.3	ns	
t <sub>COL</sub>		3.0		3.2		3.4	ns	
t <sub>DIN_D</sub>		5.4		5.6		6.2	ns	
t <sub>DIN C</sub>		4.6		5.1		6.1	ns	
t <sub>LEGLOBAL</sub>		3.1		3.5		4.3	ns	
t <sub>LABCARRY</sub>		0.6		0.7		0.8	ns	
t <sub>LABCASC</sub>		0.3		0.3		0.4	ns	

Table 37. External Reference Timing Parameters for EPF6024A Devices									
Parameter	Speed Grade								
	-1		-2		=	-3			
	Min	Max	Min	Max	Min	Max			
t <sub>1</sub>		45.0		50.0		60.0	ns		

# Device Pin-Outs

See the Altera web site (http://www.altera.com) or the *Altera Digital Library* for pin-out information.